# RICOH

# 0.5A/1A PWM/VFM Step-down DC/DC Converter with Synchronous Rectifier

No. EA-362-180919

# OUTLINE

The RP509x is a low supply current PWM/VFM step-down DC/DC converter with synchronous rectifier featuring 0.5 A/1 A output current<sup>(1)</sup>. Internally, a single converter consists of a reference voltage unit, an error amplifier, a switching control circuit, a mode control circuit, a soft-start circuit, an undervoltage lockout (UVLO) circuit, a thermal shutdown circuit, and switching transistors. The RP509x is employing synchronous rectification for improving the efficiency of rectification by replacing diodes with built-in switching transistors. Using synchronous rectification not only increases circuit performance but also allows a design to reduce parts count. Output voltage controlling method is selectable between a PWM/VFM auto-switching control type and a forced PWM control type, which further reduces noise than a normal PWM control under a light load, and these types can be set by the MODE pin. Output voltage type. Protection circuits in the RP509x is current limit circuit and thermal shutdown circuit. LX current limit value (Typ.) is selectable between 1.6 A and 1.0 A. The RP509Z is available in WLCSP-6-P6 which achieves high-density mounting on boards. Using capacitor of 0402-/1005-size (inch/mm) and inductor of 0603-/1608-size (inch/mm) as external parts help to save space for devices. The RP509N is available in SOT-23-6.

# **FEATURES**

•	Input Voltage Range (Maximum Rating)2.3 V to 5.5 V (6.5 V)
•	Output Voltage Range (Fixed Output Voltage Type)0.6 V to 3.3 V, settable in 0.1 V steps
	(Adjustable Output Voltage Type) ······ 0.6 V to 5.5 V
•	Output Voltage Accuracy (Fixed Output Voltage Type) ······· ±1.5% (V <sub>SET</sub> <sup>(2)</sup> ≥ 1.2 V), ±18 mV (V <sub>SET</sub> < 1.2 V)
•	Feedback Voltage Accuracy (Adjustable Output Voltage Type) $\cdots \pm 9 \text{ mV} (V_{FB} = 0.6 \text{ V})$
•	Output Voltage/Feedback Voltage Temperature Coefficient ···· ±100 ppm/°C
•	Selectable Oscillator Frequency Typ. 6.0 MHz
•	Oscillator Maximum Duty ······ Min. 100%
•	Built-in Driver ON Resistance ( $V_{IN}$ = 3.6 V)·······Typ. Pch. 0.175 $\Omega$ , Nch. 0.155 $\Omega$ (RP509Z)
	Typ. Pch. 0.195 Ω, Nch. 0.175 Ω (RP509N)
•	Standby Current ······
•	UVLO Detector Threshold
•	Soft-start TimeTyp. 0.15 ms
•	Inductor Current Limit Circuit Limit Limit Circuit Limit
•	Package
	SOT-23-6 ( 2.9 mm x 2.8 mm x 1.1 mm )

<sup>&</sup>lt;sup>(1)</sup> This is an approximate value. The output current is dependent on conditions and external components. <sup>(2)</sup>  $V_{SET}$  = Set Output Voltage

No. EA-362-180919

# **APPLICATIONS**

- Portable Communication Equipment: Mobiles/Smartphones, Digital Cameras and Note-PCs
- Li-ion Battery-used Equipment

# **SELECTION GUIDE**

The set output voltage, the output voltage type, the auto-discharge function<sup>(1)</sup>, and the LX current limit for the ICs are user-selectable options.

#### **Selection Guide**

Product Name Package		Quantity per Reel	Pb Free	Halogen Free
RP509ZxxX\$-E2-F	WLCSP-6-P6	5,000 pcs	Yes	Yes
RP509NxxX\$-TR-FE	SOT-23-6	3,000 pcs	Yes	Yes

xx: Specify the set output voltage (V\_{\text{SET}})

Fixed Output Voltage Type: 06 to 33 (0.6 V to 3.3 V, 0.1 V steps)

The voltage in 0.05 V step is shown as follows.

1.05 V: RP509Z101B5

1.15 V: RP509N111x5

Adjustable Output Voltage Type: 00 only

X: Specify the LX Current Limit (I<sub>LXLIM</sub>)

Тур. 1.6 А: 1

Typ. 1.0 A: 2

#### \$: Specify the version

Version	Output Voltage Type	Auto-discharge	<b>Oscillator Frequency</b>	VSET	
А	Fixed	No		0.6 V to 3.3 V	
В	Fixed	Yes	6.0 MHz		
С	Adiustable	No		0.6 V to 5.5 V	
D	Adjustable	Yes			

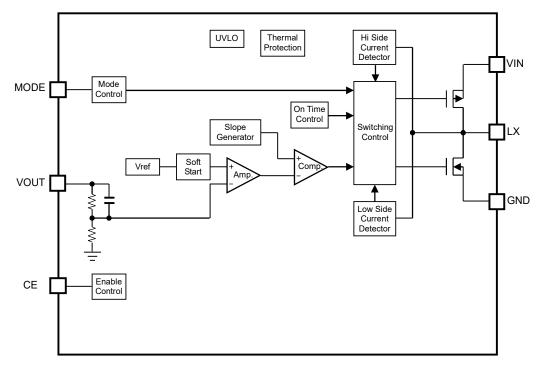
<sup>(1)</sup> Auto-discharge function quickly lowers the output voltage to 0 V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.



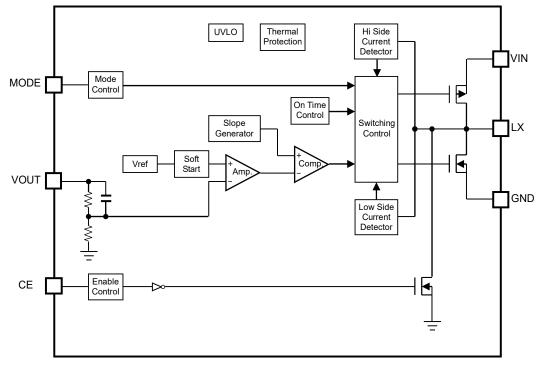
No. EA-362-180919

# **BLOCK DIAGRAM**

RP509ZxxXA/RP509ZxxXB, RP509NxxXA/RP509NxxXB (Fixed Output Voltage Type)

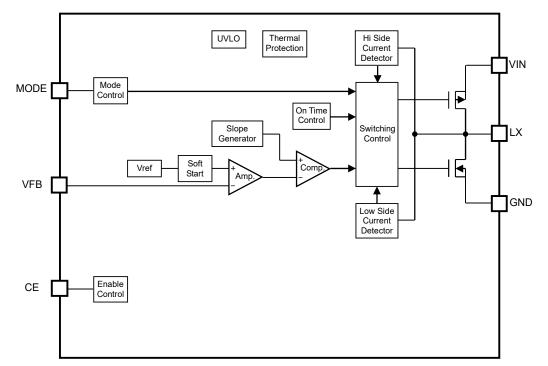


#### RP509xxxXA Block Diagram



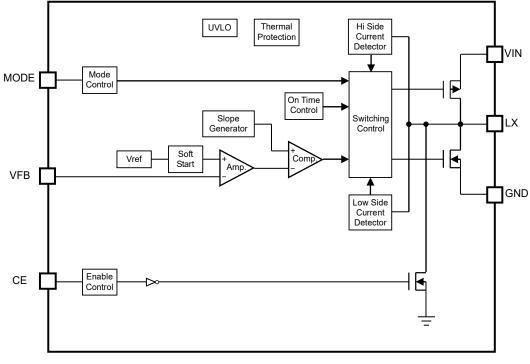
RP509xxxXB Block Diagram

No. EA-362-180919



### RP509Z00XC/RP509Z00XD, RP509N00XC/RP509N00XD (Adjustable Output Voltage Type)

#### RP509x00XC Block Diagram

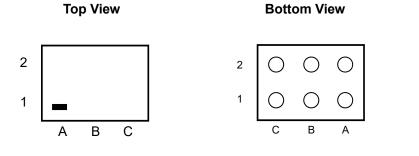


RP509x00XD Block Diagram

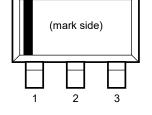
# **RICOH**

No. EA-362-180919

# **PIN DESCRIPTION**







5

6

**SOT-23-6 Pin Configurations** 

#### WLCSP-6 Pin Description

Pin No.	Symbol	Description
A1	MODE	Mode Control Pin (High: Forced PWM Control, Low: PWM/VFM Auto-switching Control)
B1	LX	Switching Pin
C1	VOUT/VFB	Output/Feedback Voltage Pin
A2	VIN	Input Voltage Pin
B2	CE	Chip Enable Pin, Active-high
C2	GND	Ground Pin

#### SOT-23-6 Pin Description

Pin No.	Symbol	Description
1	CE	Chip Enable Pin, Active-high
2	GND	Ground Pin
3	VIN	Input Voltage Pin
4	MODE	Mode Control Pin (High: Forced PWM Control, Low: PWM/VFM Auto-switching Control)
5	LX	Switching Pin
6	VOUT/VFB	Output/Feedback Voltage Pin

No. EA-362-180919

# **ABSOLUTE MAXIMUM RATINGS**

#### Absolute Maximum Ratings

Voltage	ltem		Rating	Unit				
Voltage		Item						
		Input Voltage						
n Voltage			-0.3 to V <sub>IN</sub> +0.3	V				
n Voltage		-0.3 to 6.5	V					
E Pin Volta	ige	-0.3 to 6.5	V					
/VFB Pin '	Voltage	-0.3 to 6.5	V					
n Output C	urrent	1.6	А					
r	WLCSP6-P6	JEDEC STD. 51-9 Test Land Pattern	910	mW				
Dissipation <sup>(1)</sup>	SOT-23-6	JEDEC STD. 51-7 Test Land Pattern	892	mW				
on Tempe	rature	-40 to 125	°C					
ge Temper	ature Range	-55 to 125	°C					
	ion Tempe	pation <sup>(1)</sup>	ion Temperature	ion Temperature JEDEC STD. 51-7 892 -40 to 125				

(GND = 0 V)

#### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

# **RECOMMENDED OPERATING CONDITIONS**

Symbol	Item	Rating	Unit
VIN	Input Voltage	2.3 to 5.5	V
Та	Operating Temperature Range	-40 to 85	°C

#### RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>&</sup>lt;sup>(1)</sup> Refer to *POWER DISSIPATION* for detailed information.

# **ELECTRICAL CHARACTERISTICS**

Test circuit is operated with "Open Loop Control" (GND = 0 V), unless otherwise specified.

Symbol	IA/RP509Zxx1B, RP509Nxx1A/RP	Conditions			Min.	Тур.	(Ta <b>Max</b> .	Unit
Oymbol	item i	$V_{IN} = V_{CE} = 3.6$		V <sub>SET</sub> ≥ 1.2 V	x 0.985	Typ.	x 1.015	Unit
V <sub>OUT</sub>	Output Voltage	VIN = VCE = 3.0 2.6 V), VIN = VCE = VSET - (VSET > 2.6 V)	,	V <sub>SET</sub> 2 1.2 V	-0.018		+0.018	V
ΔV <sub>OUT</sub> / ΔTa	Output Voltage Temperature Coefficient	-40 °C ≤ Ta ≤ 8	35 °C			±100		ppm/ °C
fosc	Oscillator Frequency	V <sub>IN</sub> = V <sub>CE</sub> = 3.6 Loop Control"	V, V <sub>SET</sub> =	1.8 V, "Closed	4.8	6.0	7.2	MHz
IDD	Supply Current	VIN = VCE = VOU	r = 3.6 V, V	V <sub>MODE</sub> = 0 V		15		μA
ISTANDBY	Standby Current	V <sub>IN</sub> = 5.5 V,V <sub>CE</sub>	= 0 V			0	5	μA
ICEH	CE "High" Input Current	$V_{IN} = V_{CE} = 5.5$	V		-1	0	1	μA
ICEL	CE "Low" Input Current	V <sub>IN</sub> = 5.5 V,V <sub>CE</sub>	= 0 V		-1	0	1	μA
IMODEH	MODE "High" Input Current	$V_{IN} = V_{MODE} = 5$	5 V, V <sub>CE</sub> =	0 V	-1	0	1	μA
	MODE "Low" Input Current	$V_{IN} = 5.5 V, V_{CE} = V_{MODE} = 0 V$			-1	0	1	μA
Ivouth	VOUT "High" Input Current	V <sub>IN</sub> = V <sub>OUT</sub> = 5.5 V, V <sub>CE</sub> = 0 V			-1	0	1	μA
IVOUTL	Vour "Low" Input Current	V <sub>IN</sub> = 5.5 V, V <sub>CE</sub> = V <sub>OUT</sub> = 0 V			-1	0	1	μA
Rdistr	On-resistance for Auto Discharger <sup>(1)</sup>	V <sub>IN</sub> = 3.6 V, V <sub>CE</sub> = 0 V				40		Ω
I <sub>LXLEAKH</sub>	LX "High" Leakage Current	V <sub>IN</sub> = V <sub>LX</sub> = 5.5 V, V <sub>CE</sub> = 0 V			-1	0	5	μA
ILXLEAKL	LX "Low" Leakage Current	VIN = 5.5 V, VCE	$= V_{LX} = 0$	V	-5	0	1	μA
VCEH	CE "High" Input Voltage	V <sub>IN</sub> = 5.5 V			1.0			V
VCEL	CE "Low" Input Voltage	V <sub>IN</sub> = 2.3 V					0.4	V
VMODEH	MODE "High" Input Voltage	$V_{IN} = V_{CE} = 5.5$	V		1.0			V
VMODEL	MODE "Low" Input Voltage	$V_{IN} = V_{CE} = 2.3$	V				0.4	V
<b>D</b>	On mariatana at Dah, transistan	RP509Z	V <sub>IN</sub> = 3.6 V	V,		0.175		Ω
RONP	On-resistance of Pch. transistor	RP509N	$I_{LX} = -100$	) mA		0.195		Ω
5		RP509Z	V <sub>IN</sub> = 3.6 V	V,		0.155		Ω
Ronn	On-resistance of Nch. transistor	RP509N	$I_{LX} = -100$	) mA		0.175		Ω
Maxduty	Maximum Duty Cycle				100			%
<b>İ</b> START	Soft-start Time	$V_{IN} = V_{CE} = 3.6$ $V_{IN} = V_{CE} = V_{SET}$				150	300	μs
ILXLIM	LX Current Limit	V <sub>IN</sub> = V <sub>CE</sub> = 3.6 V <sub>IN</sub> =V <sub>CE</sub> = V <sub>SET</sub>			1200	1600		mA
VUVLO1		V <sub>IN</sub> = V <sub>CE</sub> , Fallin	g		1.85	2.00	2.20	V
VUVLO2	UVLO Threshold Voltage	VIN = VCE, Risin	g		1.90	2.05	2.25	V
TTSD	Thermal Shutdown Threshold	Tj, Rising				140		°C
T <sub>TSR</sub>	Temperature	Tj, Falling			1	100		°C

		8			
All test items listed under Electrical Characteri	stics are	done under the pulse load conditi	on (Tj ≈	Ta = 25°	°C).

<sup>(1)</sup> RP509xxx1B only

No. EA-362-180919

Test circuit is operated with "Open Loop Control" (GND = 0 V), unless otherwise specified.

Symbol	Item		Conditions			Max.	Unit
VFB	Feedback Voltage	VIN = VCE =	3.6 V	0.591	<b>Typ.</b> 0.600	0.609	V
$\Delta V_{FB}/$	Feedback Voltage	-40 °C < T	40 00 4 To 4 05 00		±100		ppm
∆Ta	Temperature Coefficient	-40 0 3 1	−40 °C ≤ Ta ≤ 85 °C		100		°C
fosc	Oscillator Frequency		V <sub>IN</sub> = V <sub>CE</sub> = 3.6 V, V <sub>SET</sub> = 1.8 V, "Closed Loop Control"			7.2	MHz
IDD	Supply Current	$V_{IN} = V_{CE} =$	$V_{OUT} = 3.6V, V_{MODE} = 0V$		15		μA
ISTANDBY	Standby Current	V <sub>IN</sub> = 5.5 V	,V <sub>CE</sub> = 0 V		0	5	μA
Ісен	CE "High" Input Current	$V_{IN} = V_{CE} =$	5.5 V	-1	0	1	μA
ICEL	CE "Low" Input Current	V <sub>IN</sub> = 5.5 V	,V <sub>CE</sub> = 0 V	-1	0	1	μA
IMODEH	MODE "High" Input Current	VIN = VMODE	= = 5.5 V, V <sub>CE</sub> = 0 V	-1	0	1	μA
IMODEL	MODE "Low" Input Current	V <sub>IN</sub> = 5.5 V	, V <sub>CE</sub> = V <sub>MODE</sub> = 0 V	-1	0	1	μA
Ivouth	Vout "High" Input Current	VIN = VOUT	V <sub>IN</sub> = V <sub>OUT</sub> = 5.5 V, V <sub>CE</sub> = 0 V			1	μA
IVOUTL	Vout "Low" Input Current	V <sub>IN</sub> = 5.5 V	V <sub>IN</sub> = 5.5 V, V <sub>CE</sub> = V <sub>OUT</sub> = 0 V			1	μA
RDISTR	On-resistance for Auto Discharge <sup>(1)</sup>	V <sub>IN</sub> = 3.6 V, V <sub>CE</sub> = 0 V			40		Ω
ILXLEAKH	LX "High" Leakage Current	V <sub>IN</sub> = V <sub>LX</sub> =	V <sub>IN</sub> = V <sub>LX</sub> = 5.5 V, V <sub>CE</sub> = 0 V		0	5	μA
ILXLEAKL	LX "Low" Leakage Current	V <sub>IN</sub> = 5.5 V	, V <sub>CE</sub> = V <sub>LX</sub> = 0 V	-5	0	1	μA
VCEH	CE "High" Input Voltage	V <sub>IN</sub> = 5.5 V	V <sub>IN</sub> = 5.5 V				V
VCEL	CE "Low" Input Voltage	V <sub>IN</sub> = 2.3 V				0.4	V
VMODEH	MODE "High" Input Voltage	$V_{IN} = V_{CE} =$	5.5 V	1.0			V
V <sub>MODEL</sub>	MODE "Low" Input Voltage	$V_{IN} = V_{CE} =$	2.3 V			0.4	V
_	On-resistance of	RP509Z	V <sub>IN</sub> = 3.6 V,		0.175		Ω
Ronp	Pch. Transistor	RP509N	I <sub>LX</sub> = -100 mA		0.195		Ω
_	On-resistance of	RP509Z	V <sub>IN</sub> = 3.6 V,		0.155		Ω
Ronn	Nch. Transistor	RP509N	I <sub>LX</sub> = -100 mA		0.175		Ω
Maxduty	Maximum Duty Cycle			100			%
<b>t</b> START	Soft-start Time		3.6 V (V <sub>SET</sub> ≤ 2.6 V), V <sub>SET</sub> + 1 V (V <sub>SET</sub> > 2.6 V)		150	300	μs
I <sub>LXLIM</sub>	LX Current Limit		3.6 V (V <sub>SET</sub> ≤ 2.6 V), V <sub>SET</sub> + 1 V (V <sub>SET</sub> > 2.6 V)	1200	1600		mA
VUVLO1		VIN = VCE, F	Falling	1.85	2.00	2.20	V
VUVLO2	UVLO Threshold Voltage	VIN = VCE, F	Rising	1.90	2.05	2.25	V
TTSD	Thermal Shutdown Threshold	Tj, Rising			140		°C
T <sub>TSR</sub>	Temperature	Tj, Falling			100		°C

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj ≈ Ta = 25°C).

(1) RP509x001D only

No. EA-362-180919

Symbol	Item		Condit	ions	Min.	Тур.	Max.	Unit
Vout	Output Voltage	$V_{IN} = V_{CE} = 3$ ( $V_{SET} \le 2.6$ $V_{IN} = V_{CE} = 3$ ( $V_{SET} > 2.6$	V), V <sub>SET</sub> + 1 V	V <sub>SET</sub> ≥ 1.2 V V <sub>SET</sub> < 1.2 V	x 0.985 -0.018		x 1.015 +0.018	V
∆V <sub>о∪т</sub> / ∆Та	Output Voltage Temperature Coefficient	-40 °C ≤ Ta	, ,			±100		ppm/ °C
fosc	Oscillator Frequency	V <sub>IN</sub> = V <sub>CE</sub> = : "Closed Lo			4.8	6.0	7.2	MHz
I <sub>DD</sub>	Supply Current	$V_{IN} = V_{CE} = V_{CE}$	V <sub>OUT</sub> = 3.6	V, V <sub>MODE</sub> = 0V		15		μA
ISTANDBY	Standby Current	V <sub>IN</sub> = 5.5 V,	V <sub>CE</sub> = 0 V			0	5	μA
Ісен	CE "High" Input Current	$V_{IN} = V_{CE} =$	5.5 V		-1	0	1	μA
ICEL	CE "Low" Input Current	V <sub>IN</sub> = 5.5 V,	V <sub>CE</sub> = 0 V		-1	0	1	μA
IMODEH	MODE "High" Input Current	VIN = VMODE	= 5.5 V, V	<sub>CE</sub> = 0 V	-1	0	1	μA
IMODEL	MODE "Low" Input Current	V <sub>IN</sub> = 5.5 V,	V <sub>IN</sub> = 5.5 V, V <sub>CE</sub> = V <sub>MODE</sub> = 0 V			0	1	μA
Ivouth	Vout "High" Input Current	$V_{IN} = V_{OUT} = 5.5 V, V_{CE} = 0 V$			-1	0	1	μA
IVOUTL	V <sub>OUT</sub> "Low" Input Current	V <sub>IN</sub> = 5.5 V, V <sub>CE</sub> = V <sub>OUT</sub> = 0 V			-1	0	1	μA
RDISTR	On-resistance for Auto Discharger <sup>(1)</sup>	V <sub>IN</sub> = 3.6 V, V <sub>CE</sub> = 0 V			40		Ω	
ILXLEAKH	LX "High" Leakage Current	$V_{IN} = V_{LX} = 5.5 V, V_{CE} = 0 V$		-1	0	5	μA	
ILXLEAKL	LX "Low" Leakage Current	V <sub>IN</sub> = 5.5 V,	$V_{CE} = V_{LX}$	= 0 V	-5	0	1	μA
VCEH	CE "High" Input Voltage	V <sub>IN</sub> = 5.5 V			1.0			V
V <sub>CEL</sub>	CE "Low" Input Voltage	V <sub>IN</sub> = 2.3 V					0.4	V
V <sub>MODEH</sub>	MODE "High" Input Voltage	$V_{IN} = V_{CE} =$	5.5 V		1.0			V
VMODEL	MODE "Low" Input Voltage	$V_{IN} = V_{CE} =$	2.3 V				0.4	V
Р	On-resistance of	RP509Z	V <sub>IN</sub> = 3.6	V,		0.175		Ω
Ronp	Pch. transistor	RP509N	I <sub>LX</sub> = -10	0 mA		0.195		Ω
Р	On-resistance of	RP509Z	V <sub>IN</sub> = 3.6	V,		0.155		Ω
Ronn	Nch. transistor	RP509N	$I_{LX} = -10$	0 mA		0.175		Ω
Maxduty	Maximum Duty Cycle				100			%
t <sub>START</sub>	Soft-start Time	$V_{IN} = V_{CE} = 0$ $V_{IN} = V_{CE} = 0$		r ≤ 2.6 V), (V <sub>SET</sub> > 2.6 V)		150	300	μs
I <sub>LXLIM</sub>	LX Current Limit	$V_{IN} = V_{CE} = 0$ $V_{IN} = V_{CE} = 0$		T ≤ 2.6 V), (V <sub>SET</sub> > 2.6 V)	600	1000		mA
VUVLO1	UVLO Threshold Voltage	$V_{IN} = V_{CE,} F$	alling		1.85	2.00	2.20	V
VUVLO2		VIN = VCE, R	ising		1.90	2.05	2.25	V
TTSD	Thermal Shutdown Threshold	Tj, Rising				140		°C
T <sub>TSR</sub>	Temperature	Tj, Falling				100		°C

Test circuit is operated with "Open Loop Control" (GND = 0 V), unless otherwise specified.

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj  $\approx$  Ta = 25°C).

(1) RP509xxx2B only

No. EA-362-180919

Test circuit is operated with "Open Loop Control" (GND = 0 V), unless otherwise specified.

Symbol	ltem		Conditions			Max.	Unit
VFB	Feedback Voltage	V <sub>IN</sub> = V <sub>CE</sub> =	3.6 V	0.591	<b>Typ.</b> 0.600	0.609	V
ΔV <sub>FB</sub> / ΔTa	Feedback Voltage Temperature Coefficient	-40 °C ≤ Ta ≤ 85 °C			±100		ppm/ °C
f <sub>osc</sub>	Oscillator Frequency	$V_{IN} = V_{CE} = 3.6 \text{ V}, V_{SET} = 1.8 \text{ V},$ "Closed Loop Control"			6.0	7.2	MHz
IDD	Supply Current	$V_{IN} = V_{CE} =$	V <sub>IN</sub> = V <sub>CE</sub> = V <sub>OUT</sub> = 3.6V, V <sub>MODE</sub> = 0V				μA
ISTANDBY	Standby Current	V <sub>IN</sub> = 5.5 V,	V <sub>CE</sub> = 0 V		0	5	μA
ICEH	CE "High" Input Current	$V_{IN} = V_{CE} =$	5.5 V	-1	0	1	μA
ICEL	CE "Low" Input Current	V <sub>IN</sub> = 5.5 V,	V <sub>CE</sub> = 0 V	-1	0	1	μA
IMODEH	MODE "High" Input Current	V <sub>IN</sub> = V <sub>MODE</sub>	= 5.5 V, V <sub>CE</sub> = 0 V	-1	0	1	μA
IMODEL	MODE "Low" Input Current	V <sub>IN</sub> = 5.5 V,	V <sub>CE</sub> = V <sub>MODE</sub> = 0 V	-1	0	1	μA
Ivouth	Vout "High" Input Current	VIN = VOUT =	= 5.5 V, V <sub>CE</sub> = 0 V	-1	0	1	μA
Ivoutl	Vout "Low" Input Current	V <sub>IN</sub> = 5.5 V, V <sub>CE</sub> = V <sub>OUT</sub> = 0 V			0	1	μA
R <sub>DISTR</sub>	On-resistance for Auto Discharge <sup>(1)</sup>	V <sub>IN</sub> = 3.6 V, V <sub>CE</sub> = 0 V			40		Ω
ILXLEAKH	LX "High" Leakage Current	V <sub>IN</sub> = V <sub>LX</sub> = 5.5 V, V <sub>CE</sub> = 0 V		-1	0	5	μA
ILXLEAKL	LX "Low" Leakage Current	V <sub>IN</sub> = 5.5 V,	V <sub>IN</sub> = 5.5 V, V <sub>CE</sub> = V <sub>LX</sub> = 0 V		0	1	μA
VCEH	CE "High" Input Voltage	V <sub>IN</sub> = 5.5 V		1.0			V
V <sub>CEL</sub>	CE "Low" Input Voltage	V <sub>IN</sub> = 2.3 V				0.4	V
V <sub>MODEH</sub>	MODE "High" Input Voltage	$V_{IN} = V_{CE} =$	5.5 V	1.0			V
VMODEL	MODE "Low" Input Voltage	V <sub>IN</sub> = V <sub>CE</sub> =	2.3 V			0.4	V
Ronp	On-resistance of Pch. Transistor	RP509Z RP509N	V <sub>IN</sub> = 3.6 V, I <sub>LX</sub> = −100 mA		0.175 0.195		Ω Ω
	On-resistance of	RP509Z	V <sub>IN</sub> = 3.6 V,		0.155		Ω
Ronn	Nch. Transistor	RP509N	$I_{LX} = -100 \text{ mA}$		0.175		Ω
Maxduty	Maximum Duty Cycle			100			%
tstart	Soft-start Time		3.6 V (V <sub>SET</sub> ≤ 2.6 V), V <sub>SET</sub> + 1 V (V <sub>SET</sub> > 2.6 V)		150	300	μs
ILXLIM	LX Current Limit	$V_{IN} = V_{CE} =$	3.6 V (V <sub>SET</sub> ≤ 2.6 V), V <sub>SET</sub> +1 V (V <sub>SET</sub> > 2.6 V)	600	1000		mA
VUVLO1		VIN = VCE, F	alling	1.85	2.00	2.20	V
V <sub>UVLO2</sub>	UVLO Threshold Voltage	VIN = VCE, F	Rising	1.90	2.05	2.25	V
T <sub>TSD</sub>	Thermal Shutdown Threshold	Tj, Rising			140		°C
T <sub>TSR</sub>	Temperature	Tj, Falling		1	100		°C

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj  $\approx$  Ta = 25°C).

**RICOH** 

(1) RP509x002D only

No. EA-362-180919

#### Electrical Characteristics by Different Output Voltage

Due due	4 Norma		Max.	
Product Name		Min.		Тур.
RP509x06XA	RP509x06XB	0.582	0.600	0.618
RP509x07XA	RP509x07XB	0.682	0.700	0.718
RP509x08XA	RP509x08XB	0.782	0.800	0.818
RP509x09XA	RP509x09XB	0.882	0.900	0.918
RP509x10XA	RP509x10XB	0.982	1.000	1.018
RP509x11XA	RP509x11XB	1.082	1.100	1.118
RP509x12XA	RP509x12XB	1.182	1.200	1.218
RP509x13XA	RP509x13XB	1.281	1.300	1.319
RP509x14XA	RP509x14XB	1.379	1.400	1.421
RP509x15XA	RP509x15XB	1.478	1.500	1.522
RP509x16XA	RP509x16XB	1.576	1.600	1.624
RP509x17XA	RP509x17XB	1.675	1.700	1.725
RP509x18XA	RP509x18XB	1.773	1.800	1.827
RP509x19XA	RP509x19XB	1.872	1.900	1.928
RP509x20XA	RP509x20XB	1.970	2.000	2.030
RP509x21XA	RP509x21XB	2.069	2.100	2.131
RP509x22XA	RP509x22XB	2.167	2.200	2.233
RP509x23XA	RP509x23XB	2.266	2.300	2.334
RP509x24XA	RP509x24XB	2.364	2.400	2.436
RP509x25XA	RP509x25XB	2.463	2.500	2.537
RP509x26XA	RP509x26XB	2.561	2.600	2.639
RP509x27XA	RP509x27XB	2.660	2.700	2.740
RP509x28XA	RP509x28XB	2.758	2.800	2.842
RP509x29XA	RP509x29XB	2.857	2.900	2.943
RP509x30XA	RP509x30XB	2.955	3.000	3.045
RP509x31XA	RP509x31XB	3.054	3.100	3.146
RP509x32XA	RP509x32XB	3.152	3.200	3.248
RP509x33XA	RP509x33XB	3.251	3.300	3.349
_	RP509Z101B5	1.032	1.050	1.068
RP509N111A5	RP509N111B5	1.132	1.150	1.168
_	RP509Z112B5	1.132	1.150	1.168

#### <u>RP509x</u>

No. EA-362-180919

### **OPERATING DESCRIPTIONS**

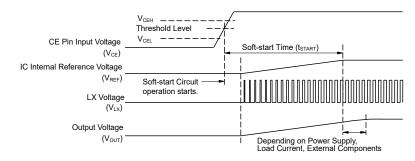
#### Soft-start Time

#### Starting-up with CE Pin

The IC starts to operate when the CE pin voltage ( $V_{CE}$ ) exceeds the threshold voltage. The threshold voltage is preset between CE "H" input voltage ( $V_{CEH}$ ) and CE "Low" input voltage ( $V_{CEL}$ ).

After the start-of the start-up of the IC, soft-start circuit starts to operate. Then, after a certain period of time, the reference voltage ( $V_{REF}$ ) in the IC gradually increases up to the specified value.

Notes: Soft start time  $(t_{START})^{(1)}$  is not always equal to the turn-on speed of the step-down DC/DC converter. Please note that the turn-on speed could be affected by the power supply capacity, the output current, the inductance value and the C<sub>OUT</sub> value.

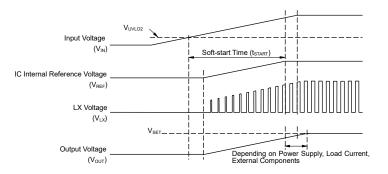


Timing Chart when Starting-up with CE Pin

#### Starting-up with Power Supply

After the power-on, when  $V_{IN}$  exceeds the UVLO released voltage ( $V_{UVLO2}$ ), the IC starts to operate. Then, softstart circuit starts to operate and after a certain period of time,  $V_{REF}$  gradually increases up to the specified value.

Notes: Please note that the turn-on speed of  $V_{OUT}$  could be affected by the power supply capacity, the output current, the inductance value, the  $C_{OUT}$  value and the turn-on speed of  $V_{IN}$  determined by  $C_{IN}$ .



Timing Chart when Starting-up with Power Supply

<sup>&</sup>lt;sup>(1)</sup> Soft-start time (t<sub>START</sub>) indicates the duration until the reference voltage (V<sub>REF</sub>) reaches the specified voltage after softstart circuit's activation.

#### <u>RP509x</u>

No. EA-362-180919

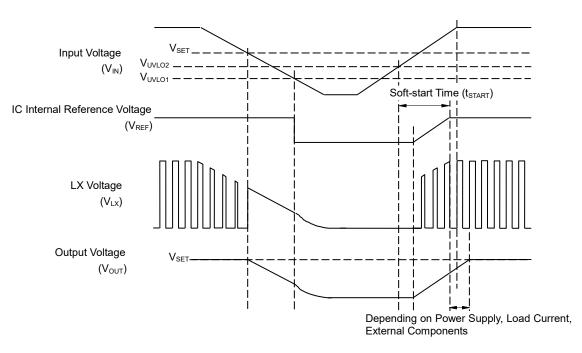
#### Undervoltage Lockout (UVLO) Circuit

If  $V_{IN}$  becomes lower than  $V_{SET}$ , the step-down DC/DC converter stops the switching operation and ON duty becomes 100%, and then  $V_{OUT}$  gradually drops according to  $V_{IN}$ .

If the  $V_{IN}$  drops more and becomes lower than the UVLO detector threshold ( $V_{UVLO1}$ ), the UVLO circuit starts to operate,  $V_{REF}$  stops, and Pch. and Nch. built-in switch transistors turn "OFF". As a result,  $V_{OUT}$  drops according to the  $C_{OUT}$  capacitance value and the load.

To restart the operation,  $V_{IN}$  needs to be higher than  $V_{UVLO2}$ . The timing chart below shows the voltage shifts of  $V_{REF}$ ,  $V_{LX}$  and  $V_{OUT}$  when  $V_{IN}$  value is varied.

Notes: Falling edge (operating) and rising edge (releasing) waveforms of  $V_{OUT}$  could be affected by the initial voltage of  $C_{OUT}$  and the output current of  $V_{OUT}$ .



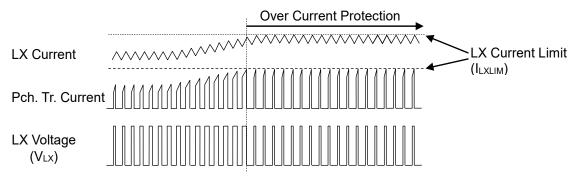
Timing Chart with Variations in Input Voltage (VIN)

No. EA-362-180919

#### **Current Limit Circuit**

Current limit circuit supervises the inductor peak current (the peak current flowing through Pch. Tr.) in each switching cycle, and if the current exceeds the LX current limit ( $I_{LXLIM}$ ), it turns off Pch. Tr.  $I_{LXLIM}$  of the RP509x is set to Typ.1.6 A or Typ.1.0 A.

Notes:  $I_{LXLIM}$  could be easily affected by self-heating or ambient environment. If the  $V_{IN}$  drops dramatically or becomes unstable due to short-circuit, protection operation could be affected.

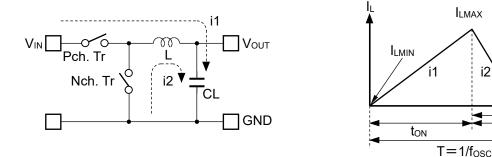


**Over-Current Protection Operation** 

No. EA-362-180919

#### Operation of Step-down DC/DC Converter and Output Current

The step-down DC/DC converter charges energy in the inductor when LX Tr. turns "ON", and discharges the energy from the inductor when LX Tr. turns "OFF" and controls with less energy loss, so that a lower output voltage ( $V_{OUT}$ ) than the input voltage ( $V_{IN}$ ) can be obtained. The operation of the step-down DC/DC converter is explained in the following figures.



**Basic Circuit** 

Inductor Current (IL) flowing through Inductor (L)

**t**OPEN

toff

- Step1. Pch. Tr. turns "ON" and I<sub>L</sub> (i1) flows, L is charged with energy. At this moment, i1 increases from the minimum inductor current (I<sub>LMIN</sub>), which is 0 A, and reaches the maximum inductor current (I<sub>LMAX</sub>) in proportion to the on-time period (t<sub>ON</sub>) of Pch. Tr.
- **Step2.** When Pch. Tr. turns "OFF", L tries to maintain  $I_L$  at  $I_{LMAX}$ , so L turns Nch Tr. "ON" and  $I_L$  (i2) flows into L.
- **Step3.** i2 decreases gradually and reaches I<sub>LMIN</sub> after the open-time period (t<sub>OPEN</sub>) of Nch. Tr., and then Nch. Tr. turns "OFF". This is called discontinuous current mode.

As the output current ( $I_{OUT}$ ) increases, the off-time period ( $t_{OFF}$ ) of Pch. Tr. runs out before  $I_{L}$  reaches  $I_{LMIN}$ . The next cycle starts, and Pch. Tr. turns "ON" and Nch. Tr. turns "OFF", which means  $I_{L}$  starts increasing from  $I_{LMIN}$ . This is called continuous current mode.

In PWM mode,  $V_{OUT}$  is maintained by controlling ton. The oscillator frequency ( $f_{OSC}$ ) is maintained constant during PWM mode.

When the step-down DC/DC operation is constant,  $I_{LMIN}$  and  $I_{LMAX}$  during ton of Pch. Tr. would be same as during to<sub>FF</sub> of Pch. Tr. The current differential between  $I_{LMAX}$  and  $I_{LMIN}$  is described as  $\Delta I$ , as the following equation 1.

 $\Delta I = I_{LMAX} - I_{LMIN} = V_{OUT} \times t_{OPEN} / L = (V_{IN} - V_{OUT}) \times t_{ON} / L$ Equation 1

The above equation is predicated on the following requirements.

 $T = 1 / f_{OSC} = t_{ON} + t_{OFF}$ duty (%) = t\_{ON} / T × 100 = t\_{ON} × f\_{OSC} × 100 t\_{OPEN} \le t\_{OFF}

In Equation 1, "V<sub>OUT</sub> × t<sub>OPEN</sub> / L" shows the amount of current change in "OFF" state. Also, "(V<sub>IN</sub> – V<sub>OUT</sub>) × t<sub>ON</sub> / L" shows the amount of current change at "ON" state.

No. EA-362-180919

#### **Discontinuous Mode and Continuous Mode**

As illustrated in Figure A., when  $I_{OUT}$  is relatively small,  $t_{OPEN} < t_{OFF}$ . In this case, the energy charged into L during  $t_{ON}$  will be completely discharged during  $t_{OFF}$ , as a result,  $I_{LMIN} = 0$ . This is called discontinuous mode. When  $I_{OUT}$  is gradually increased, eventually  $t_{OPEN} = t_{OFF}$  and when  $I_{OUT}$  is increased further, eventually  $I_{LMIN} > 0$  as illustrated in Figure B. This is called continuous mode.

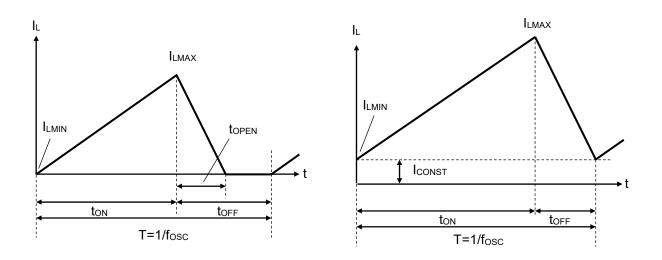


Figure A. Discontinuous Mode

Figure B. Continuous Mode

In the continuous mode, the solution of Equation 1 is described as  $t_{ONC}$ .

tonc = T × V<sub>OUT</sub> / V<sub>IN</sub>······ Equation 2

When  $t_{ON} < t_{ONC}$ , it is discontinuous mode, and when  $t_{ON} = t_{ONC}$ , it is continuous mode.

#### Forced PWM Mode and VFM Mode

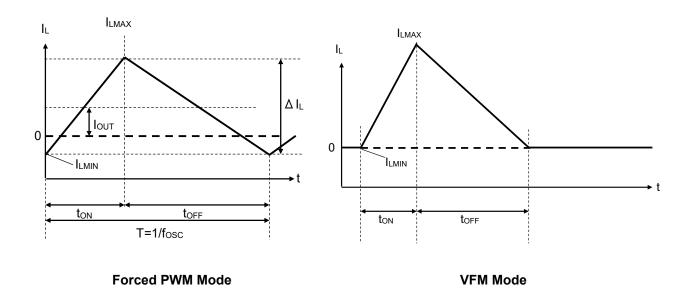
Output voltage controlling method is selectable between a forced PWM control type and a PWM/VFM autoswitching control type, and can be set by the MODE pin. The forced PWM control switches at fixed frequency rate in order to reduce noise in low output current. The PWM/VFM auto-switching control automatically switches from PWM mode to VFM mode in order to achieve high efficiency in low output current.

#### Forced PWM Mode

By setting the MODE pin to "H", the IC switches the frequency at the fixed rate to reduce noise even when the output load is light. Therefore, when  $I_{OUT}$  is  $\Delta I_L/2$  or less,  $I_{LMIN}$  becomes less than "0". That is, the accumulated electricity in CL is discharged through the IC side while  $I_L$  is increasing from  $I_{LMIN}$  to "0" during ton, and also while  $I_L$  is decreasing from "0" to  $I_{LMIN}$  during toFF.

#### VFM Mode

By setting the MODE pin to "Low", in low output current, the IC automatically switches into VFM mode in order to achieve high efficiency. In VFM mode, ton is determined depending on  $V_{IN}$  and  $V_{OUT}$ .

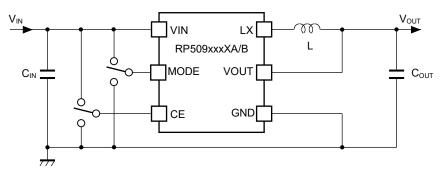


No. EA-362-180919

# **APPLICATION INFORMATION**

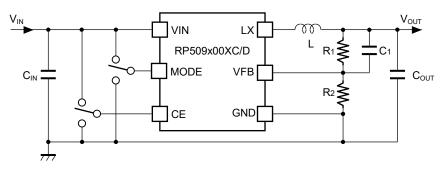
#### **Typical Application Circuits**

MODE = High: Forced PWM Control, MODE = Low: PWM/VFM Auto-switching Control



RP509xxxXA/RP509xxxXB (Fixed Output Voltage Type)

MODE = High: Forced PWM Control, MODE = Low: PWM/VFM Auto-switching Control



RP509x00XC/RP509x00XD (Adjustable Output Voltage Type)

#### **Recommended External Components**

Symbol	Descriptions		
C	4.7 μF and more, Ceramic Capacitor,		
CIN	See the table of "Input Voltage vs. Capacitance" in the following page.		
0	10 μF, Ceramic Capacitor,		
Соит	See the table of "Set Output Voltage ( $V_{SET}$ ) vs. Capacitance" in the following page.		
	0.47 μH to 0.56 μH,		
L	See the table of "Inductance Range vs. PWM Frequency" in the following page.		

No. EA-362-180919

<b>V</b> IN <b>[V]</b>	Size [mm]	С <sub>і№</sub> [µF]	Rated Voltage [V]	Model
	1005	4.7	6.3	JMK105BBJ475MV (Taiyo Yuden)
	1005	10	6.3	C1005X5R0J106M050BC (TDK)
				GRM188R60J475ME84 (Murata)
		4.7	6.3	GRM188R60J475ME19 (Murata)
Up to 4.5		4.7	0.3	C1608X5R0J475M080AB (TDK)
	1608			JMK107BJ475MA (Taiyo Yuden)
			10 6.3	GRM188R60J106ME47 (Murata)
		10		C1608X5R0J106M080AB (TDK)
				JMK107ABJ106MA (Taiyo Yuden
	1005	10	6.3	C1005X5R0J106M050BC (TDK)
				GRM188R60J475ME84 (Murata)
		4.7	6.3	GRM188R60J475ME19 (Murata)
Up to 5.5	1000			JMK107BJ475MA (Taiyo Yuden)
	1608	800		GRM188R60J106ME47 (Murata)
	1	10	10 6.3	C1608X5R0J106M080AB (TDK)
				JMK107ABJ106MA (Taiyo Yuden

#### Input Voltage vs. Capacitance

#### Set Output Voltage (VSET) vs. Capacitance

Version	Vset [V]	Size [mm]	С <sub>оυт</sub> [µF]	Rated Voltage [V]	Model
		1005	10	4	GRM155R60G106ME44 (Murata) C1005X5R0G106M050BB (TDK) AMK105CBJ106MV (Taiyo Yuden)
	0.6 to 1.8		10	6.3	C1005X5R0J106M050BC (TDK)
RP509xxxXA RP509xxxXB or RP509x00XC RP509x00XD		1608	10	6.3	GRM188R60J106ME47 (Murata) C1608X5R0J106M080AB (TDK) JMK107ABJ106MA (Taiyo Yuden)
	1.9 to 3.3	1005	10	4	GRM155R60G106ME44(Murata) C1005X5R0G106M050BB (TDK) AMK105CBJ106MV (Taiyo Yuden)
			10	6.3	C1005X5R0J106M050BC (TDK)
		1608	10	6.3	GRM188R60J106ME47 (Murata) C1608X5R0J106M080AB (TDK) JMK107ABJ106MA (Taiyo Yuden)
RP509x00XC RP509x00XD	3.4 to 4.5	1608	10	6.3	GRM188R60J106ME47 (Murata) C1608X5R0J106M080AB (TDK) JMK107ABJ106MA (Taiyo Yuden)

No. EA-362-180919

Version	PWM Frequency [MHz]	Size [mm]	Height(Max) [mm]	L [µH]	Rdc (Typ) [mΩ]	Model				
		1608	0.95	0.47	110	MDT1608-CHR47M (TOKO)				
	6.0	1000		0.47	90	MDT1608-CRR47M (TOKO)				
RP509xxxXA		.0		0.5	60	MIPSZ2012D0R5 (FDK)				
RP509xxxXB or RP509x00XC RP509x00XD				0.56	65	MDT2012-CRR56N (TOKO)				
				0.47	70	MLP2012HR47MT (TDK)				
		2012	2012	2012 1.0	2012	1.0	1.0	0.54	65	MLP2012HR54MT (TDK)
						0.47	60	CKP2012NR47M-T (Taiyo Yuden)		
				0.47	48	BRL2012TR47M6 (Taiyo Yuden)				
				0.47	75	LQM21PNR47MG0 (Murata)				

#### Inductance Range vs. PWM Frequency

#### **Precautions for the Selection of External Parts**

- Choose a low ESR ceramic capacitor. The capacitance of C<sub>IN</sub> between V<sub>IN</sub> and GND should be more than or equal to 4.7 μF. The capacitance of a ceramic capacitor (C<sub>OUT</sub>) should be 10 μF. Also, choose the capacitor with consideration for bias characteristics and input/output voltages. See the above tables of "Input Voltage vs. Capacitance" and "Set Output Voltage vs. Capacitance".
- The phase compensation of this device is designed according to the C<sub>OUT</sub> and L values. The inductance range of an inductor should be between 0.47µH to 0.56 µH in order to gain stability. See the above table of "Inductance Range vs. PWM Frequency".
- Choose an inductor that has small DC resistance, has enough permissible current and is hard to cause magnetic saturation. If the inductance value of the inductor becomes extremely small under the load conditions, the peak current of LX may increase along with the load current. As a result, over current protection circuit may start to operate when the peak current of LX reaches to LX limit current. Therefore, choose an inductor with consideration for the value of I<sub>LXMAX</sub>. See the following page of "Calculation Conditions of LX Pin Maximum Output Current (I<sub>LXMAX</sub>)".
- As for the adjustable output voltage type (RP509x00XC/RP509x00XD), the set output voltage (V<sub>SET</sub>) can be arbitrarily set by changing the vales of R1 and R2 using the following equation: V<sub>SET</sub> = V<sub>FB</sub> × (R1 + R2) / R2

Refer to the following table for the recommended values for R1, R2 and C1.

VSET [V]	R1 [kΩ]	R2 [kΩ]	C1 [pF]
0.6	0	220	Open
$0.6 < V_{SET} \le 0.9$		220	47
$0.9 < V_{SET} \le 1.8$		220	33
1.8 < V <sub>SET</sub> ≤ 2.1		150	10
2.1 < V <sub>SET</sub> ≤ 2.4	R1 = (V <sub>SET</sub> / V <sub>FB</sub> -1 ) x R2	100	10
$2.4 < V_{SET} \le 2.7$		68	10
$2.7 < V_{SET} \le 3.0$		47	10
$3.0 < V_{SET} \leq V_{IN}$		47	6.8

#### Set Output Voltage (V<sub>SET</sub>) vs. R1/R2/C1 (Adjustable Output Voltage Type)

No. EA-362-180919

#### Calculation Conditions of LX Pin Maximum Output Current (I<sub>LXMAX</sub>)

The following equations explain the relationship to determine  $I_{LXMAX}$  at the ideal operation of the ICs in continuous mode.

Ripple Current P-P value is described as I<sub>RP</sub>, ON resistance of Pch. Tr. is described as R<sub>ONP</sub>, ON resistance of Nch. Tr. is described as R<sub>ONN</sub>, and DC resistor of the inductor is described as R<sub>L</sub>.

First, when Pch. Tr. is "ON", Equation 1 is satisfied.

$V_{IN} = V_{OUT} + (R_{ONP} + R_L) \times I_{OUT} + L \times I_{RP} / t_{ON}$ Equation 1			
Second, when Pch. Tr. is "OFF" (Nch. Tr. is "ON"), Equation 2 is satisfied.			
$L \times I_{RP} / t_{OFF} = R_{ONN} \times I_{OUT} + V_{OUT} + R_L \times I_{OUT} \cdots			
Put Equation 2 into Equation 1 to solve ON duty of Pch. Tr. ( $D_{ON} = t_{ON} / (t_{OFF} + t_{ON})$ ):			
$D_{ON} = (V_{OUT} + R_{ONN} \times I_{OUT} + R_{L} \times I_{OUT}) / (V_{IN} + R_{ONN} \times I_{OUT} - R_{ONP} \times I_{OUT}) \cdots Equation 3$			
Ripple Current is described as follows:			
$I_{RP} = (V_{IN} - V_{OUT} - R_{ONP} \times I_{OUT} - R_{L} \times I_{OUT}) \times D_{ON} / f_{OSC} / L$ Equation 4			
Peak current that flows through L, and LX Tr. is described as follows:			
I <sub>LXMAX</sub> = I <sub>OUT</sub> + I <sub>RP</sub> / 2····· Equation 5			

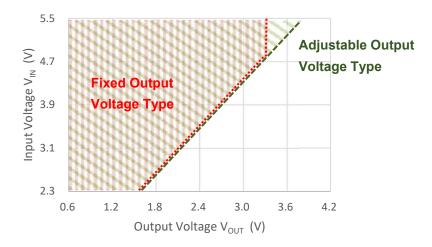
No. EA-362-180919

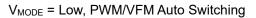
# **TECHNICAL NOTES**

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed its rated voltage, rated current or rated power. When designing a peripheral circuit, please be fully aware of the following points.

- Set the external components as close as possible to the IC and minimize the wiring between the components and the IC. Especially, place a capacitor (C<sub>IN</sub>) as close as possible to the VIN pin and GND.
- Ensure the VIN and GND lines are sufficiently robust. If their impedance is too high, noise pickup or unstable operation may result.
- The VIN line, the GND line, the VOUT line, an inductor, and LX should make special considerations for the large switching current flows.
- The wiring between the VOUT pin and an inductor (L) (RP509xxxXA/RP509xxxXB) or between a resistor for setting output voltage (R1) and L (RP509x00XC/RP509x00XD) should be separated from the wiring between L and Load.
- Over current protection circuit may be affected by self-heating or power dissipation environment.
- For any setting type of output voltage, the input/output voltage ratio must meet the following requirement to achieve a stable VFM mode at light load when the MODE pin is "Low" (at PWM/VFM Auto Switching):

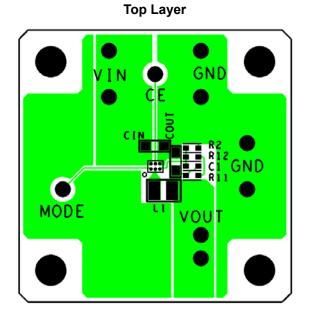
 $V_{OUT}$  /  $V_{IN}$  < 0.7



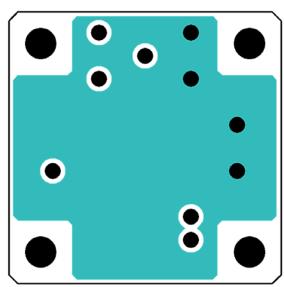


Available Voltage Area with Stable VFM Mode

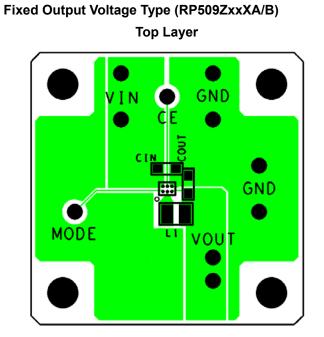
# **RICOH**



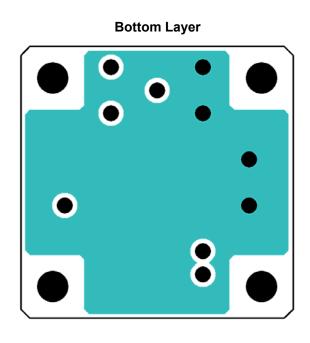
Adjustable Output Voltage Type (RP509Z00XC/D)



Bottom Layer



PCB LAYOUT

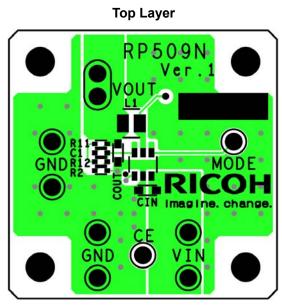


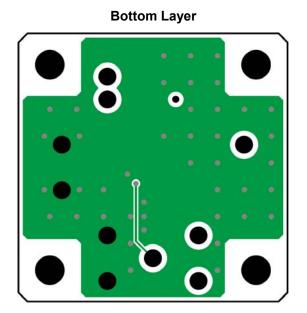
No. EA-362-180919

**RP509x** 

No. EA-362-180919

#### Adjustable Output Voltage Type (RP509N00XC/D)





# RICOH

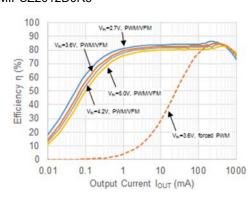
No. EA-362-180919

# **TYPICAL CHARACTERISTICS**

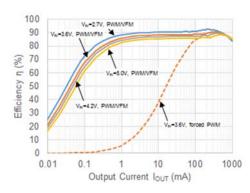
Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

#### 1) Efficiency vs. Output Current (RP509Z)

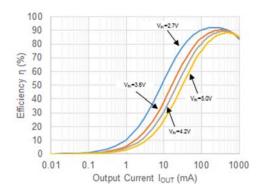
 $V_{OUT}$  = 1.0 V  $V_{MODE}$  = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5



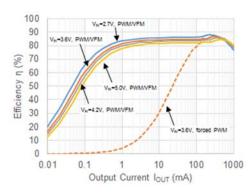
 $V_{OUT}$  = 1.8 V  $V_{MODE}$  = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5



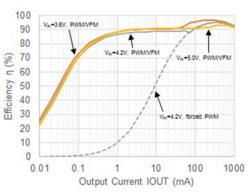
 $\label{eq:Vout} \begin{array}{l} \mathsf{V}_{\mathsf{OUT}} = 1.8 \ \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \ \mathsf{Forced} \ \mathsf{PWM} \ \mathsf{Mode} \\ \mathsf{L} = \mathsf{MIPSZ2012D0R5} \end{array}$ 



 $V_{OUT}$  = 1.2 V  $V_{MODE}$  = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5



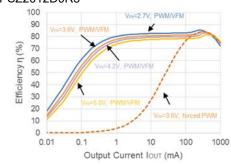
 $V_{OUT}$  = 3.3 V (Fixed Output Voltage Type)  $V_{MODE}$  = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5



No. EA-362-180919

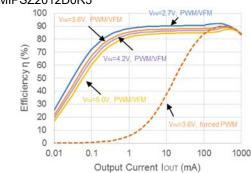
#### Efficiency vs. Output Current (RP509N)

Vout = 1.0 V V<sub>MODE</sub> = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5

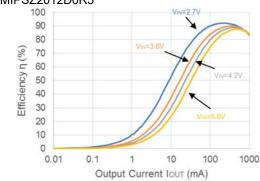


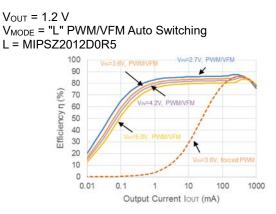
V<sub>OUT</sub> = 1.8 V V<sub>MODE</sub> = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5



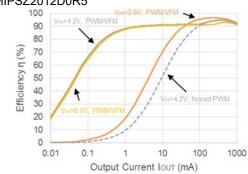


Vout = 1.8 V V<sub>MODE</sub> = "H" Forced PWM Mode L = MIPSZ2012D0R5





V<sub>OUT</sub> = 3.3 V (Fixed Output Voltage Type) V<sub>MODE</sub> = "L" PWM/VFM Auto Switching L = MIPSZ2012D0R5

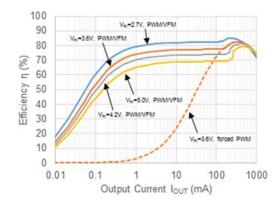


#### <u>RP509x</u>

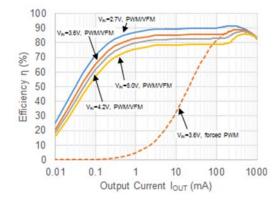
No. EA-362-180919

#### Small Mount Solution (RP509Z) Vout = 1.0 V

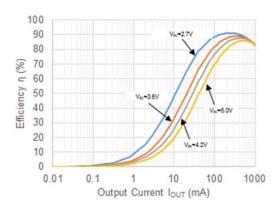
 $V_{MODE}$  = "L" PWM/VFM Auto Switching L = MDT1608-CRR47M



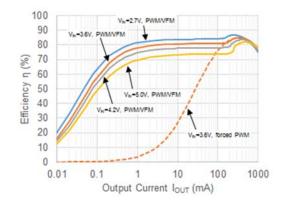
 $\label{eq:Vout} \begin{array}{l} V_{OUT} = 1.8 \ V \\ V_{MODE} = "L" \ PWM/VFM \ Auto \ Switching \\ L = MDT1608\text{-}CRR47M \end{array}$ 



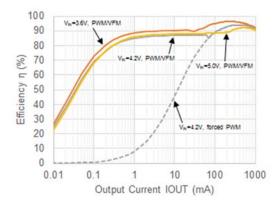
 $\label{eq:Vout} \begin{array}{l} \mathsf{V}_{\mathsf{OUT}} = 1.8 \ \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \ \mathsf{Forced} \ \mathsf{PWM} \ \mathsf{Mode} \\ \mathsf{L} = \mathsf{MDT1608}\text{-}\mathsf{CRR47M} \end{array}$ 



 $V_{OUT}$  = 1.2 V  $V_{MODE}$  = "L" PWM/VFM Auto Switching L = MDT1608-CRR47M



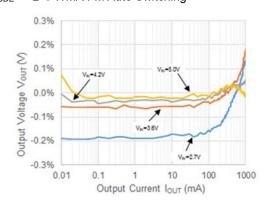
V<sub>OUT</sub> = 3.3 V (Fixed Output Voltage Type) V<sub>MODE</sub> = "L" PWM/VFM Auto Switching L = MDT1608-CRR47M

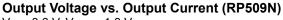


No. EA-362-180919

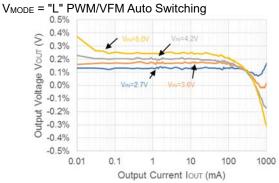
#### 2) Output Voltage vs. Output Current (RP509Z)

 $V_{IN}$  = 3.6 V,  $V_{OUT}$  = 1.8 V  $V_{MODE}$  = "L" PWM/VFM Auto Switching

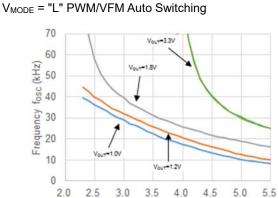




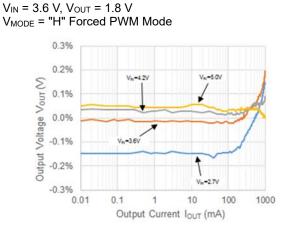
V<sub>IN</sub> = 3.6 V, V<sub>OUT</sub> = 1.8 V

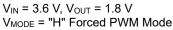


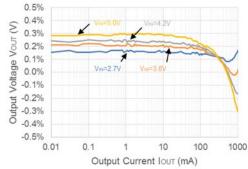
3) Oscillator Frequency vs. Input Voltage Iout = 1.0 mA



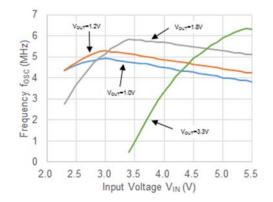
Input Voltage VIN (V)







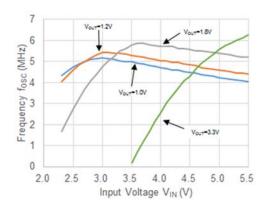
 $I_{OUT}$  = 1.0 mA V<sub>MODE</sub> = "H" Forced PWM Mode



# RICOH

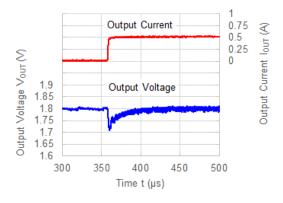
No. EA-362-180919

 $I_{OUT}$  = 500 mA V<sub>MODE</sub> = "H" Forced PWM Mode

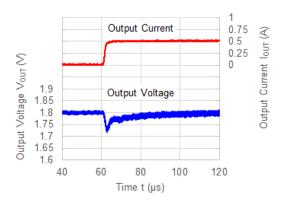


4) Load Transient Response Waveform  $V_{IN} = 3.6 V, V_{OUT} = 1.8 V$  $V_{MODE} = "L" PWM/VFM Auto Switching$ 

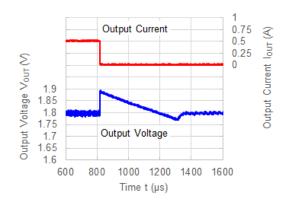
V<sub>MODE</sub> = "L" PWM/VFM Auto Switchin Iout = 1.0 -> 500 mA



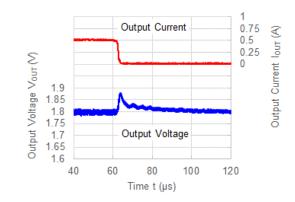
 $\label{eq:VIN} \begin{array}{l} \mathsf{V}_{\mathsf{IN}} = 3.6 \ \mathsf{V}, \ \mathsf{V}_{\mathsf{OUT}} = 1.8 \ \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \ \mathsf{Forced} \ \mathsf{PWM} \ \mathsf{Mode} \\ \mathsf{I}_{\mathsf{OUT}} = 1.0 \ \text{--} 500 \ \mathsf{mA} \end{array}$ 



 $\label{eq:VIN} \begin{array}{l} V_{IN} = 3.6 \ V, \ V_{OUT} = 1.8 \ V \\ V_{MODE} = "L" \ PWM/VFM \ Auto \ Switching \\ I_{OUT} = 500 \ -> 1.0 \ mA \end{array}$ 

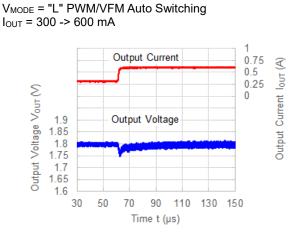


 $\label{eq:VIN} \begin{array}{l} \mathsf{V}_{\mathsf{IN}} = 3.6 \ \mathsf{V}, \ \mathsf{V}_{\mathsf{OUT}} = 1.8 \ \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \ \mathsf{Forced} \ \mathsf{PWM} \ \mathsf{Mode} \\ \mathsf{I}_{\mathsf{OUT}} = 500 \ \text{->} 1.0 \ \mathsf{mA} \end{array}$ 

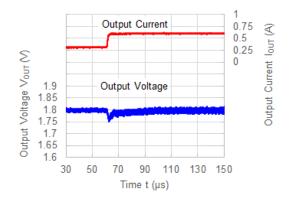


#### No. EA-362-180919

V<sub>IN</sub> = 3.6 V, V<sub>OUT</sub> = 1.8 V

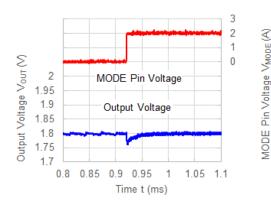


 $\label{eq:VIN} \begin{array}{l} \mathsf{V}_{\mathsf{IN}} = 3.6 \ \mathsf{V}, \ \mathsf{V}_{\mathsf{OUT}} = 1.8 \ \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \ \mathsf{Forced} \ \mathsf{PWM} \ \mathsf{Mode} \\ \mathsf{I}_{\mathsf{OUT}} = 300 \ \mathsf{->} \ 600 \ \mathsf{mA} \end{array}$ 

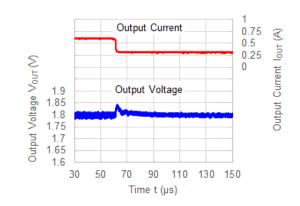




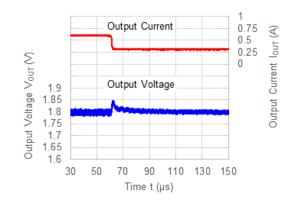
V<sub>IN</sub> = 3.6 V, V<sub>OUT</sub> = 1.8 V I<sub>OUT</sub> = 1.0 mA V<sub>MODE</sub> = "L" -> "H"



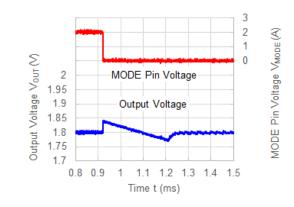
 $\label{eq:VIN} \begin{array}{l} V_{IN} = 3.6 \mbox{ V}, V_{OUT} = 1.8 \mbox{ V} \\ V_{MODE} = "L" \mbox{ PWM/VFM} \mbox{ Auto Switching} \\ I_{OUT} = 600 \mbox{ -> } 300 \mbox{ mA} \end{array}$ 



 $\label{eq:VIN} \begin{array}{l} V_{\text{IN}} = 3.6 \text{ V}, \ V_{\text{OUT}} = 1.8 \text{ V} \\ V_{\text{MODE}} = "H" \ \text{Forced PWM Mode} \\ I_{\text{OUT}} = 600 \ \text{->} \ 300 \ \text{mA} \end{array}$ 



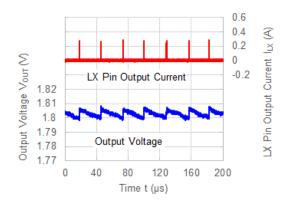
V<sub>IN</sub> = 3.6 V, V<sub>OUT</sub> = 1.8 V I<sub>OUT</sub> = 1.0 mA V<sub>MODE</sub> = "H" -> "L"



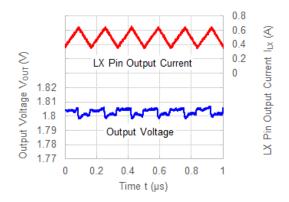
#### <u>RP509x</u>

No. EA-362-180919

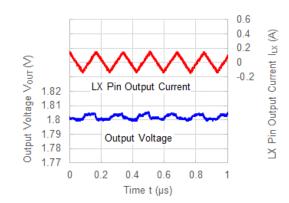




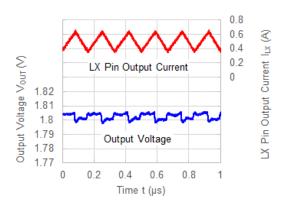
 $\label{eq:VIN} \begin{array}{l} V_{\text{IN}} = 3.6 \text{ V}, \ V_{\text{OUT}} = 1.8 \text{ V} \\ V_{\text{MODE}} = "L" \ PWM/VFM \ Auto \ Switching \\ I_{\text{OUT}} = 500 \ mA \end{array}$ 



 $\label{eq:VIN} \begin{array}{l} \mathsf{V}_{\mathsf{IN}} = 3.6 \ \mathsf{V}, \ \mathsf{V}_{\mathsf{OUT}} = 1.8 \ \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \ \mathsf{Forced} \ \mathsf{PWM} \ \mathsf{Mode} \\ \mathsf{I}_{\mathsf{OUT}} = 1.0 \ \mathsf{mA} \end{array}$ 



 $\label{eq:VIN} \begin{array}{l} \mathsf{V}_{\mathsf{IN}} = 3.6 \; \mathsf{V}, \; \mathsf{V}_{\mathsf{OUT}} = 1.8 \; \mathsf{V} \\ \mathsf{V}_{\mathsf{MODE}} = "\mathsf{H}" \; \mathsf{Forced} \; \mathsf{PWM} \; \mathsf{Mode} \\ \mathsf{I}_{\mathsf{OUT}} = 500 \; \mathsf{mA} \end{array}$ 



# POWER DISSIPATION

# WLCSP-6-P6

Ver. C

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-9.

#### **Measurement Conditions**

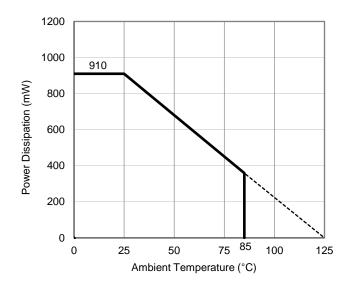
Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	101.5 mm x 114.5 mm x 1.6 mm
Copper Ratio	Outer Layers (First and Fourth Layers): 60% Inner Layers (Second and Third Layers): 100%

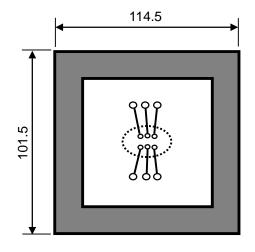
#### **Measurement Result**

(Ta = 25°C, Tjmax = 125°C)

Item	Measurement Result
Power Dissipation	910 mW
Thermal Resistance (θja)	θja = 109°C/W

θja: Junction-to-Ambient Thermal Resistance







**Measurement Board Pattern** 

# PACKAGE DIMENSIONS

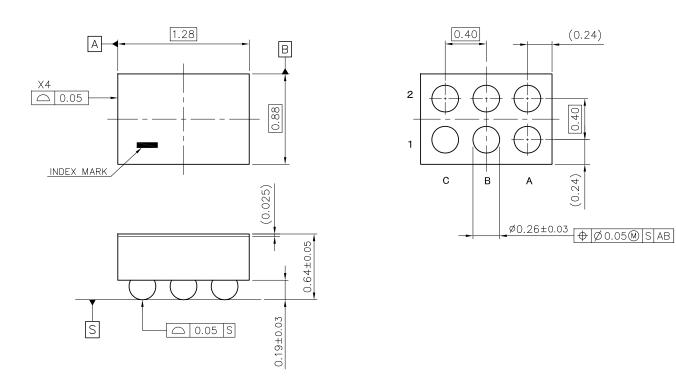
# WLCSP-6-P6

(0.24)

0.40

(0.24)

Ver. B



#### WLCSP-6-P6 Package Dimensions (Unit: mm)

# **RICOH**

# VISUAL INSPECTION CRITERIA

# WLCSP

VI-160823

No.	Inspection Items	Inspection Criteria	Figure
1	Package chipping	A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected And, Package chipping to Si surface and to bump is rejected.	B ↓ C
2	Si surface chipping	A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected But, even if A≥0.2mm, B≤0.1mm is acceptable.	B t C
3	No bump	No bump is rejected.	
4	Marking miss	To reject incorrect marking, such as another product name marking or another lot No. marking.	
5	No marking	To reject no marking on the package.	
6	Reverse direction of marking	To reject reverse direction of marking character.	
7	Defective marking	To reject unreadable marking. (Microscope: X15/ White LED/ Viewed from vertical direction)	
8	Scratch	To reject unreadable marking character by scratch. (Microscope: X15/ White LED/ Viewed from vertical direction)	
9	Stain and Foreign material	To reject unreadable marking character by stain and foreign material. (Microscope: X15/ White LED/ Viewed from vertical direction)	

# POWER DISSIPATION

# SOT-23-6-D

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$ 

Ver. B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

ltem	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 7 pcs

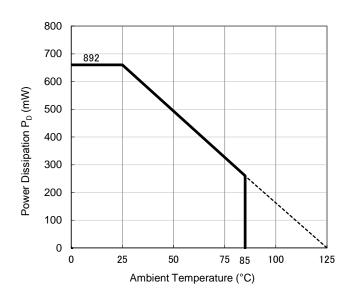
#### **Measurement Conditions**

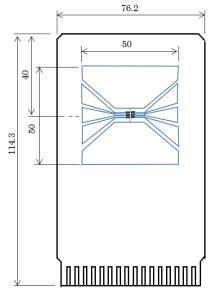
#### **Measurement Result**

Item	Measurement Result		
Power Dissipation	892 mW		
Thermal Resistance (θja)	θja = 112°C/W		
Thermal Characterization Parameter (ψjt)	ψjt = 51°C/W		

θja: Junction-to-Ambient Thermal Resistance

wjt: Junction-to-Top Thermal Characterization Parameter





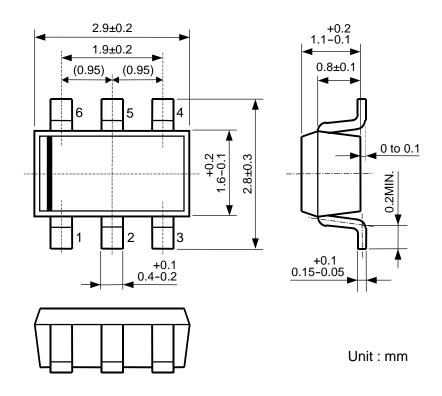
Power Dissipation vs. Ambient Temperature

**Measurement Board Pattern** 

# PACKAGE DIMENSIONS

# SOT-23-6

Ver. A





# RICOH

- 1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to Ricoh sales representatives for the latest information thereon.
- 2. The materials in this document may not be copied or otherwise reproduced in whole or in part without prior written consent of Ricoh.
- 3. Please be sure to take any necessary formalities under relevant laws or regulations before exporting or otherwise taking out of your country the products or the technical information described herein.
- 4. The technical information described in this document shows typical characteristics of and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under Ricoh's or any third party's intellectual property rights or any other rights.
- 5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death (aircraft, spacevehicle, nuclear reactor control system, traffic control system, automotive and transportation equipment, combustion equipment, safety devices, life support system etc.) should first contact us.
- 6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. Anti-radiation design is not implemented in the products described in this document.
- 8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact Ricoh sales or our distributor before attempting to use AOI.
- 11. Please contact Ricoh sales representatives should you have any questions or comments concerning the products or the technical information.



**Ricoh is committed to reducing the environmental loading materials in electrical devices with a view to contributing to the protection of human health and the environment.** Ricoh has been providing RoHS compliant products since April 1, 2006 and Halogen-free products since April 1, 2012.

# **RICOH** RICOH ELECTRONIC DEVICES CO., LTD.

https://www.e-devices.ricoh.co.jp/en/

#### Sales & Support Offices

#### Ricoh Electronic Devices Co., Ltd.

Shin-Yokohama Office (International Sales) 2-3, Shin-Yokohama 3-chome, Kohoku-ku, Yokohama-shi, Kanagawa, 222-8530, Japan Phone: +81-50-3814-7687 Fax: +81-45-474-0074

Ricoh Americas Holdings, Inc. 675 Campbell Technology Parkway, Suite 200 Campbell, CA 95008, U.S.A. Phone: +1-408-610-3105

#### Ricoh Europe (Netherlands) B.V. Semiconductor Support Centre

Prof. W.H. Keesomlaan 1, 1183 DJ Amstelveen, The Netherlands Phone: +31-20-5474-309

Ricoh International B.V. - German Branch Semiconductor Sales and Support Centre Oberrather Strasse 6, 40472 Düsseldorf, Germany Phone: +49::211-6546-0

Ricoh Electronic Devices Korea Co., Ltd. 3F, Haesung Bldg, 504, Teheran-ro, Gangnam-gu, Seoul, 135-725, Korea Phone: +82-2-2135-5700 Fax: +82-2-2051-5713

#### Ricoh Electronic Devices Shanghai Co., Ltd. Room 403, No.2 Building, No.690 Bibo Road, Pu Dong New District, Shanghai 201203, People's Republic of China Phone: +86-21-5027-3200 Fax: +86-21-5027-3299

Ricoh Electronic Devices Shanghai Co., Ltd.

Shenzhen Branch 1205, Block D(Jinlong Building), Kingkey 100, Hongbao Road, Luohu District, Shenzhen, China Phone: +86:755-8348-7600 Ext 225

#### Ricoh Electronic Devices Co., Ltd.

 Taipei office

 Room 109, 10F-1, No.51, Hengyang Rd., Taipei City, Taiwan

 Phone: +886-2-2313-1621/1622

 Fax: +886-2-2313-1621/1622

